FAIRCHILD SEMICONDUCTOR

20V N-Channel PowerTrench[®] MOSFET

General Description

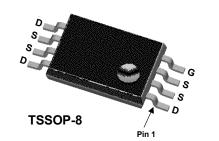
This N-Channel MOSFET is a rugged gate version of Fairchild Semiconductor's advanced PowerTrench process. It has been optimized for power management applications requiring a wide range of gate drive voltage ratings (2.5V to 12V).

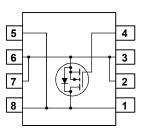
Applications

- Battery protection
- DC/DC conversion
- Power management
- Load switch

Features

- 7.8 A, 20 V $R_{DS(ON)} = 15 \text{ m}\Omega @ V_{GS} = 4.5 \text{ V}$ $R_{DS(ON)} = 22 \text{ m}\Omega @ V_{GS} = 2.5 \text{ V}$
- Extended V_{GSS} range (±12V) for battery applications
- High performance trench technology for extremely low $R_{\text{DS}(\text{ON})}$
- Low profile TSSOP-8 package





Absolute Maximum Ratings T_A=25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
V _{DSS}	Drain-Source Voltage		20	V
V _{GSS}	Gate-Source Voltage	± 12		
ID	Drain Current – Continuous	(Note 1)	7.8	А
	– Pulsed		30	
PD	Power Dissipation	(Note 1a)	1.4	W
		(Note 1b)	1.1	
T _J , T _{STG}	Operating and Storage Junction Temp	erature Range	–55 to +150	°C
	I Characteristics	ient (Note 1a)	87	°C/W
I herma R _{0JA}	Thermal Resistance, Junction-to-Ambi	ient (Note 1a) (Note 1b)	87 114	°C/W
R _{θJA}		(Note 1b)		°C/W
R _{eja} Packag	Thermal Resistance, Junction-to-Ambi	(Note 1b)		C/W

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Off Cha BV _{DSS}	Parameter	Test Conditions	Min	Тур	Max	Units
BVnss	racteristics					1
- 000	Drain-Source Breakdown Voltage	$V_{GS} = 0 V$, $I_D = 250 \mu A$	20			V
<u>ΔBV_{DSS}</u> ΔT _J	Breakdown Voltage Temperature Coefficient	I_D = 250 µA, Referenced to 25°C		14		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 20 V, V _{GS} = 0 V			1	μA
		V_{DS} = 20 V, V_{GS} = 0 V, T_{J} =55°C			25	
I _{GSSF}	Gate-Body Leakage, Forward	V _{GS} = 12 V, V _{DS} = 0 V			100	nA
I _{GSSR}	Gate-Body Leakage, Reverse	$V_{GS} = -12 V$, $V_{DS} = 0 V$			-100	nA
On Cha	racteristics (Note 2)					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	0.6	1.0	1.5	V
$rac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	I_D = 250 µA, Referenced to 25°C		-3.5		mV/°C
R _{DS(on)}	Static Drain–Source	V_{GS} = 4.5 V, I_{D} = 7.8 A		12	15	mΩ
	On–Resistance	V_{GS} = 2.5 V, I_{D} = 6.3 A		19	22	
I _{D(on)}	On–State Drain Current	V_{GS} = 10 V, V_{DS} = 5 V	20			A
g _{FS}	Forward Transconductance	$V_{DS} = 10 V$, $I_D = 7.8 A$		33		S
Dynami	c Characteristics					
Ciss	Input Capacitance	$V_{DS} = 10 V$, $V_{GS} = 0 V$,		1320		pF
Coss	Output Capacitance	f = 1.0 MHz		396		pF
C _{rss}	Reverse Transfer Capacitance			211		pF
Switchi	ng Characteristics (Note 2)					
t _{d(on)}	Turn–On Delay Time	$V_{DD} = 10 V$, $I_D = 1 A$,		7	14	ns
	Turn–On Rise Time	V_{GS} = 10 V, R_{GEN} = 6 Ω		12	22	ns
t _r				30	48	ns
t _r t _{d(off)}	Turn–Off Delay Time				20	ns
	Turn–Off Delay Time Turn–Off Fall Time	-		11	20	110
t _{d(off)}	-	V _{GS} = 0 V, I _F = 1.5 A, dI _F /dt = 100A/μs		11 23	80	ns
t _{d(off)} t _f	Turn–Off Fall Time					
t _{d(off)} t _f t _{rr}	Turn–Off Fall Time Reverse Recovery Time	dI _F /dt = 100A/µs		23	80	ns
t _{d(off)} t _f t _{rr}	Turn–Off Fall Time Reverse Recovery Time Total Gate Charge			23 14	80	ns nC
t _{d(off)} t _f t _{rr} Q _g Q _{gs} Q _{gg}	Turn–Off Fall Time Reverse Recovery Time Total Gate Charge Gate–Source Charge			23 14 3	80	ns nC nC
t _{d(off)} t _f t _{rr} Q _g Q _{gs} Q _{gg}	Turn-Off Fall Time Reverse Recovery Time Total Gate Charge Gate-Source Charge Gate-Drain Charge	$dI_{F}/dt = 100A/\mu s$ $V_{DS} = 10 V, I_{D} = 7.8 A,$ $V_{GS} = 4.5 V$ and Maximum Ratings		23 14 3	80	ns nC nC

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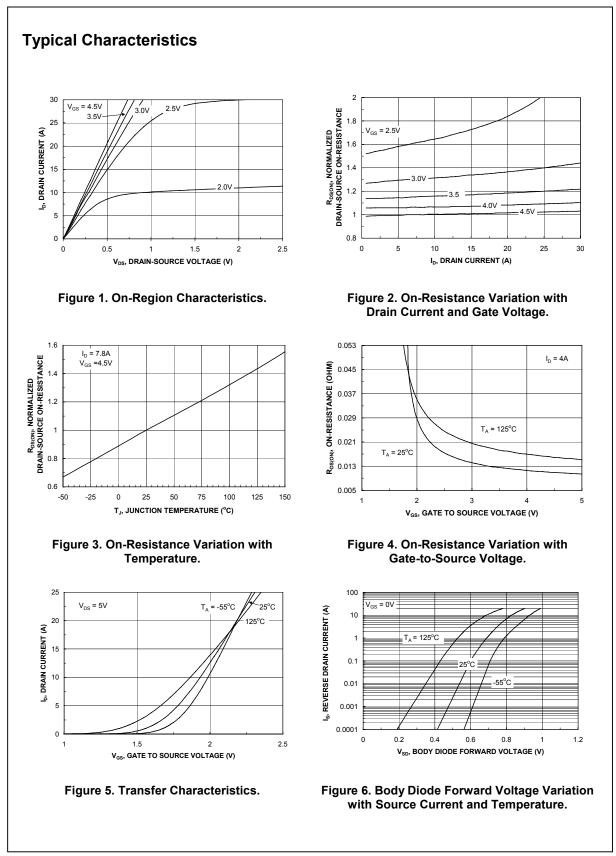
2.Pulse Test: Pulse Width < 300µs, Duty Cycle < 2.0%

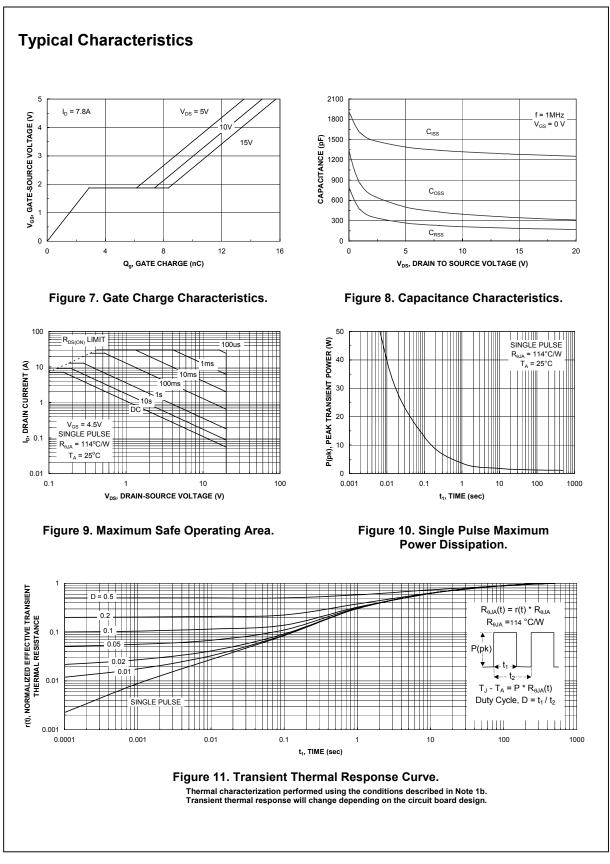
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• Low profile TSSOP-8 package

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Applications

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Product status/pricing/packaging

Product	Product status	Pricing*	Package type	Leads	Package marking	Packing method
SI6466DQ	Full Production	\$0.81	TSSOP	8	\$Y&3 6466	TAPE REEL

* 1,000 piece Budgetary Pricing

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